

TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

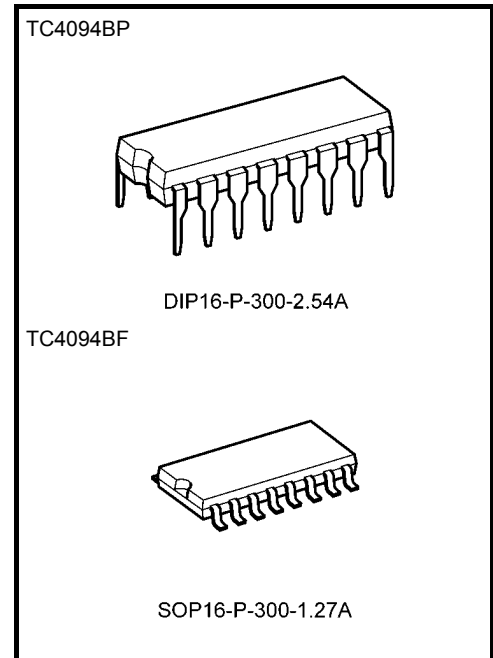
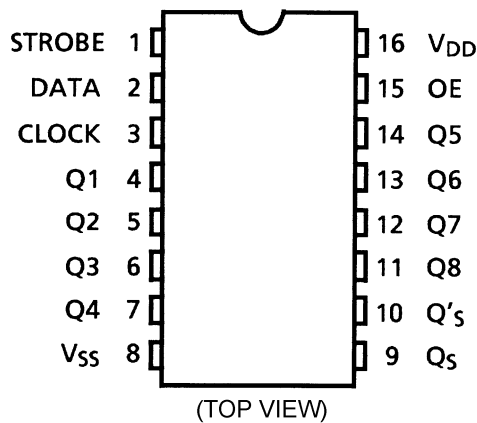
TC4094BP, TC4094BF

TC4094B 8-Stage Shift-and-Store Bus-Register

TC4094B is a SHIFT and STORE REGISTER that consists of an 8-bit shift register and an 8-bit latch. The read data in the shift register can be taken in the latch through the asynchronous STROBE input; therefore, the data transfer mode can hold output. And, since the parallel outputs is of 3-state construction, it can be directly connected to the 8-bit busline.

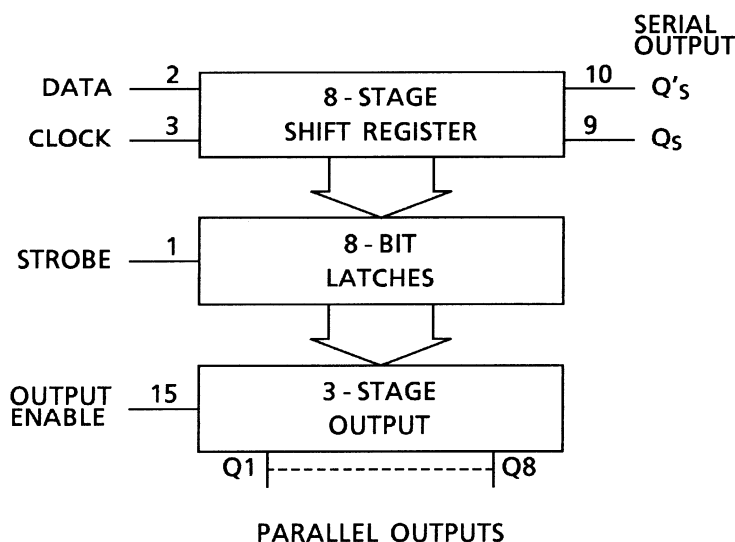
This register can be applied to Serial-to-parallel conversion, data receivers, etc.

Pin Assignment



Weight
 DIP16-P-300-2.54A : 1.00 g (typ.)
 SOP16-P-300-1.27A : 0.18 g (typ.)

Block Diagram



Truth Table

CL	OE	ST	D	PO		SO	
				Q1	Qn	Qs	Q's
	H	H	L	L	Qn - 1	Q7	NC
	H	H	H	H	Qn - 1	Q7	NC
	H	L	X	NC	NC	Q7	NC
	L	X	X	HZ	HZ	Q7	NC
	H	X	X	NC	NC	NC	Qs
	L	X	X	HZ	HZ	NC	Qs

CL = Clock

X = Don't care

OE = Output enable

NC = No change

ST = Strobe

HZ = High impedance

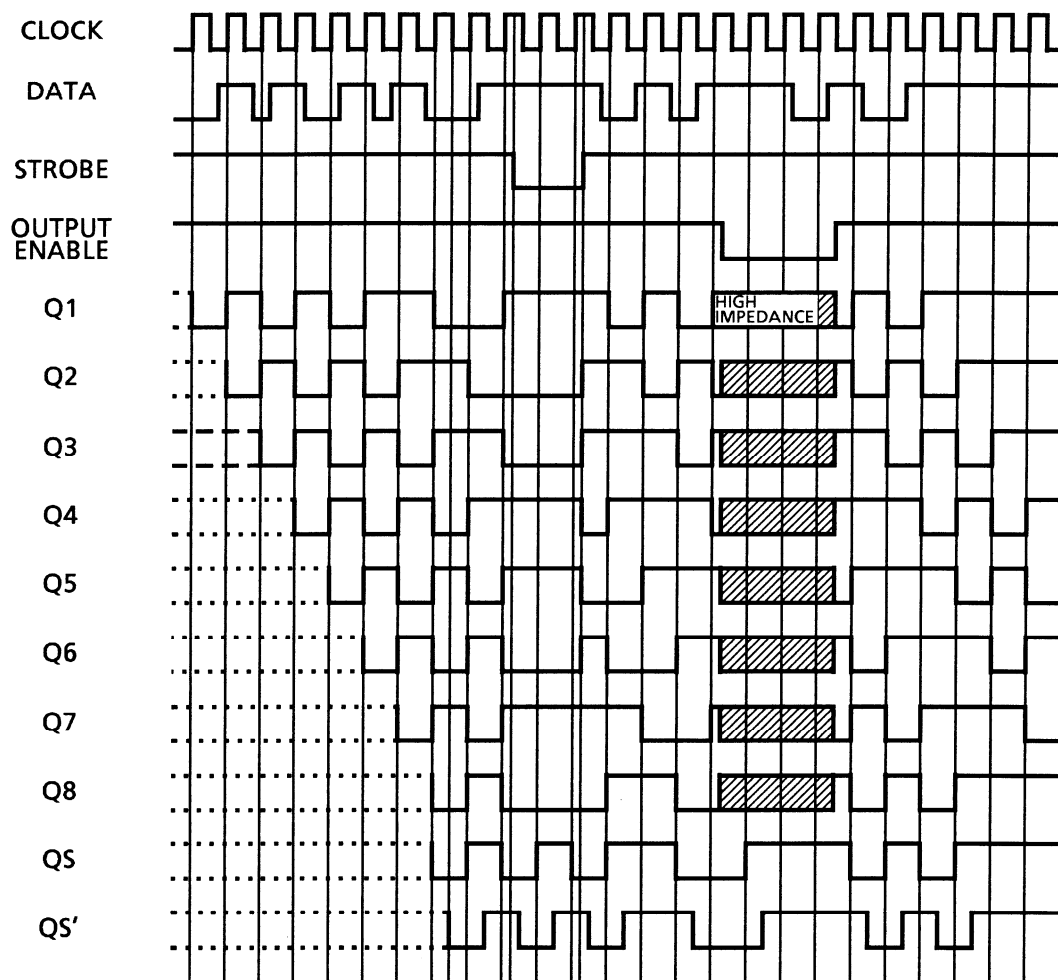
D = Data

PO = Parallel outputs

SO = Serial outputs

The diagram illustrates a 10-bit shift register circuit. It features three primary inputs: DATA, CLOCK, and STROBE. The DATA input is inverted and connected to the D input of the first flip-flop. The CLOCK input is connected to the CK input of all flip-flops. The STROBE input is inverted and connected to the ST input of all flip-flops. The circuit consists of ten D-type flip-flops, each labeled with 'D', 'Q', 'CK', and 'F/F'. The Q output of the first flip-flop is connected to the D input of the second, and so on, forming a chain. The Q output of the tenth flip-flop is connected to the CK input of the first flip-flop, forming a feedback loop. The Q output of the first flip-flop is also connected to the D input of the first of eight output buffers. Each output buffer consists of a 2-input NAND gate and a 2-input OR gate. The Q output of the first flip-flop is connected to the inputs of the first NAND gate. The Q output of the second flip-flop is connected to the inputs of the first OR gate. The output of the first NAND gate is connected to the input of the first OR gate, and the output of the first OR gate is connected to the output of the first NAND gate. This configuration forms a buffer for the Q output of the first flip-flop. The output of the first buffer is labeled Q1. The output of the second buffer is labeled Q2, and so on, up to Q8. The output of the eighth buffer is labeled Q8. The output of the ninth buffer is labeled QS, and the output of the tenth buffer is labeled QS'.

Timing Chart



Absolute Maximum Ratings (Note)

Characteristics	Symbol	Rating	Unit
DC supply voltage	V_{DD}	$V_{SS} - 0.5$ to $V_{SS} + 20$	V
Input voltage	V_{IN}	$V_{SS} - 0.5$ to $V_{DD} + 0.5$	V
Output voltage	V_{OUT}	$V_{SS} - 0.5$ to $V_{DD} + 0.5$	V
DC input current	I_{IN}	± 10	mA
Power dissipation	P_D	300 (DIP)/180 (SOIC)	mW
Operating temperature range	T_{opr}	-40 to 85	°C
Storage temperature range	T_{stg}	-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Operating Ranges ($V_{SS} = 0$ V) (Note)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
DC supply voltage	V_{DD}	—	3	—	18	V
Input voltage	V_{IN}	—	0	—	V_{DD}	V

Note: The operating ranges must be maintained to ensure the normal operation of the device.
Unused inputs must be tied to either V_{DD} or V_{SS} .

Static Electrical Characteristics ($V_{SS} = 0$ V)

Characteristics		Sym- bol	Test Condition	-40°C			25°C			85°C		Unit
				V_{DD} (V)	Min	Max	Min	Typ.	Max	Min	Max	
High-level output voltage		V_{OH}	$ I_{OUT} < 1 \mu A$ $V_{IN} = V_{SS}, V_{DD}$	5	4.95	—	4.95	5.00	—	4.95	—	V
				10	9.95	—	9.95	10.00	—	9.95	—	
				15	14.95	—	14.95	15.00	—	14.95	—	
Low-level output voltage		V_{OL}	$ I_{OUT} < 1 \mu A$ $V_{IN} = V_{SS}, V_{DD}$	5	—	0.05	—	0.00	0.05	—	0.05	V
				10	—	0.05	—	0.00	0.05	—	0.05	
				15	—	0.05	—	0.00	0.05	—	0.05	
Output high current		I_{OH}	$V_{OH} = 4.6$ V	5	-0.61	—	-0.51	-1.0	—	-0.42	—	mA
			$V_{OH} = 2.5$ V	5	-2.50	—	-2.10	-4.0	—	-1.70	—	
			$V_{OH} = 9.5$ V	10	-1.50	—	-1.30	-2.2	—	-1.10	—	
			$V_{OH} = 13.5$ V	15	-4.00	—	-3.40	-9.0	—	-2.80	—	
			$V_{IN} = V_{SS}, V_{DD}$									
Output low current		I_{OL}	$V_{OL} = 0.4$ V	5	0.61	—	0.51	1.2	—	0.42	—	mA
			$V_{OL} = 0.5$ V	10	1.50	—	1.30	3.2	—	1.10	—	
			$V_{OL} = 1.5$ V	15	4.00	—	3.40	12.0	—	2.80	—	
			$V_{IN} = V_{SS}, V_{DD}$									
Input high voltage		V_{IH}	$V_{OUT} = 0.5$ V, 4.5 V	5	3.5	—	3.5	2.75	—	3.5	—	V
			$V_{OUT} = 1.0$ V, 9.0 V	10	7.0	—	7.0	5.50	—	7.0	—	
			$V_{OUT} = 1.5$ V, 13.5 V	15	11.0	—	11.0	8.25	—	11.0	—	
			$ I_{OUT} < 1 \mu A$									
Input low voltage		V_{IL}	$V_{OUT} = 0.5$ V, 4.5 V	5	—	1.5	—	2.25	1.5	—	1.5	V
			$V_{OUT} = 1.0$ V, 9.0 V	10	—	3.0	—	4.50	3.0	—	3.0	
			$V_{OUT} = 1.5$ V, 13.5 V	15	—	4.0	—	6.75	4.0	—	4.0	
			$ I_{OUT} < 1 \mu A$									
Input current	"H" level	I_{IH}	$V_{IH} = 18$ V	18	—	0.1	—	10^{-5}	0.1	—	1.0	μA
	"L" level	I_{IL}	$V_{IL} = 0$ V	18	—	-0.1	—	-10^{-5}	-0.1	—	-1.0	
3-state output leakage current	"H" level	I_{DH}	$V_{out} = 18$ V	18	—	0.4	—	10^{-4}	0.4	—	12	μA
	"L" level	I_{DL}	$V_{out} = 0$ V	18	—	-0.4	—	-10^{-4}	-0.4	—	-12	
Quiescent supply current		I_{DD}	$V_{IN} = V_{SS}, V_{DD}$ (Note)	5	—	5	—	0.005	5	—	150	μA
				10	—	10	—	0.010	10	—	300	
				15	—	20	—	0.015	20	—	600	

Note: All valid input combinations.

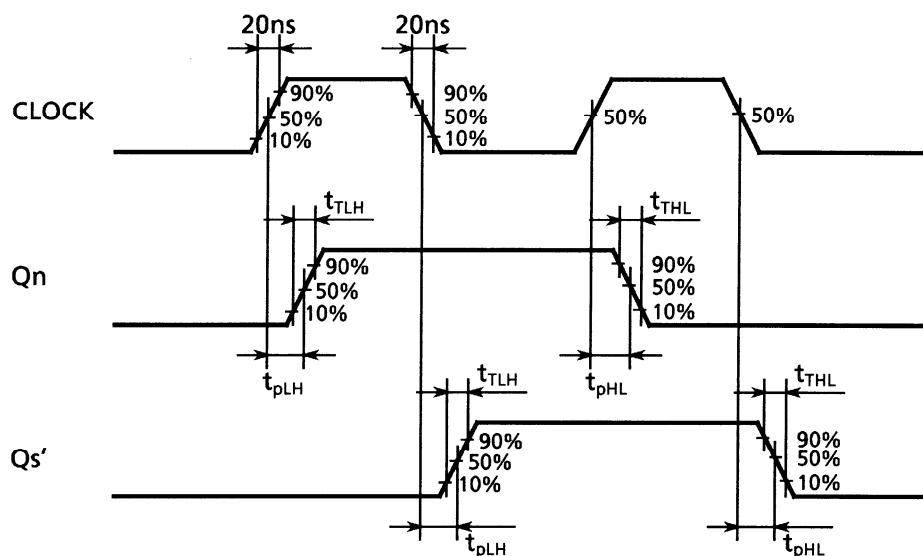
Dynamic Electrical Characteristics (Ta = 25°C, V_{SS} = 0 V, C_L = 50 pF)

Characteristics	Symbol	Test Condition	V _{DD} (V)	Min	Typ.	Max	Unit
Output transition time (low to high)	t _{TLH}	—	5	—	70	200	ns
			10	—	35	100	
			15	—	30	80	
Output transition time (high to low)	t _{THL}	—	5	—	70	200	ns
			10	—	35	100	
			15	—	30	80	
Propagation delay time (CLOCK-Q _S)	t _{PLH} t _{pHL}	—	5	—	150	600	ns
			10	—	75	250	
			15	—	55	190	
Propagation delay time (CLOCK-Q _S ')	t _{PLH} t _{pHL}	—	5	—	155	460	ns
			10	—	75	220	
			15	—	55	150	
Propagation delay time (CLOCK-Q _n)	t _{PLH} t _{pHL}	—	5	—	190	840	ns
			10	—	90	390	
			15	—	65	270	
Propagation delay time (STROBE-Q _n)	t _{PLH} t _{pHL}	—	5	—	150	580	ns
			10	—	70	290	
			15	—	50	200	
Three state disable time (OUTPUT ENABLE-Q _n)	t _{PHZ} t _{PZH}	R _L = 1 kΩ	5	—	60	200	ns
			10	—	35	100	
			15	—	30	80	
Three state disable time (OUTPUT ENABLE-Q _n)	t _{PLZ} t _{PZL}	R _L = 1 kΩ	5	—	70	200	ns
			10	—	40	100	
			15	—	35	80	
Min clock pulse width	t _w	—	5	—	45	200	ns
			10	—	20	100	
			15	—	15	80	
Min pulse width (STROBE)	t _{WH}	—	5	—	40	200	ns
			10	—	20	80	
			15	—	15	70	
Max clock frequency	f _{CL}	—	5	1.25	6	—	MHz
			10	2.50	12	—	
			15	3.00	16	—	
Min set-up time (DATA-CLOCK)	t _{SU}	—	5	—	0	120	ns
			10	—	0	55	
			15	—	0	35	
Min hold time (DATA-CLOCK)	t _H	—	5	—	10	40	ns
			10	—	10	20	
			15	—	5	15	
Min set-up time (CLOCK-STROBE)	t _{SU}	—	5	—	90	200	ns
			10	—	40	100	
			15	—	30	80	

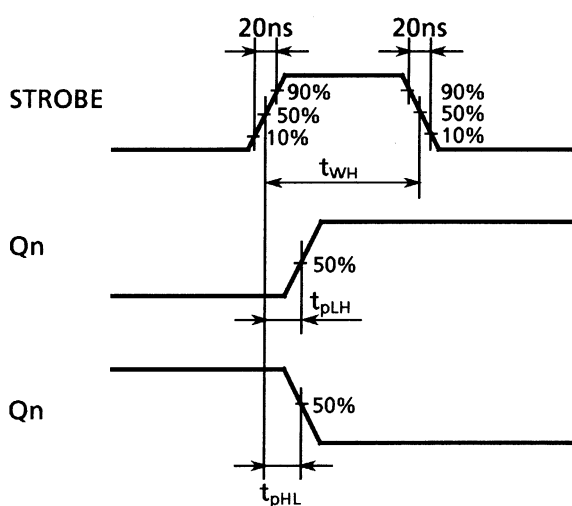
Characteristics	Symbol	Test Condition		Min	Typ.	Max	Unit
			V _{DD} (V)				
Min hold time (CLOCK-STROBE)	t _H	—	5	—	—	0	ns
			10	—	—	0	
			15	—	—	0	
Max clock input rise time	t _{rCL}	—	5	No limit			μs
Max clock input fall time	t _{fCL}		10				
			15				
Input capacitance	C _{IN}	—		—	5	7.5	pF

Waveforms for Measurement of Dynamic Characteristics

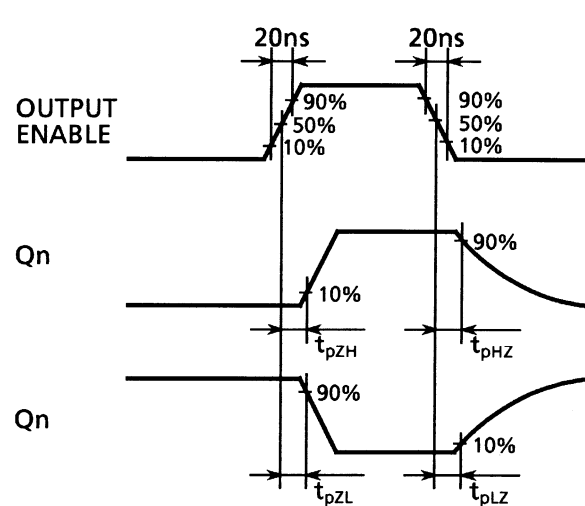
Waveform 1



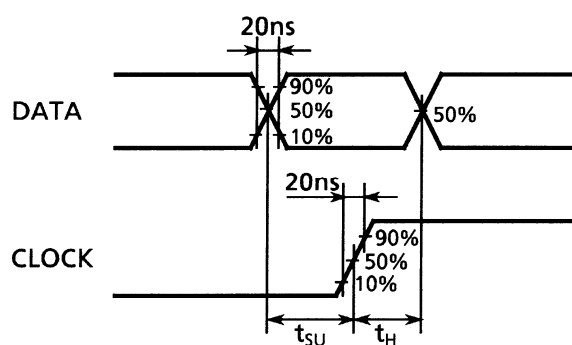
Waveform 2



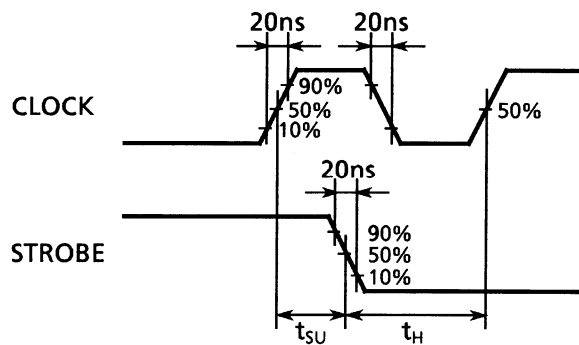
Waveform 3



Waveform 4



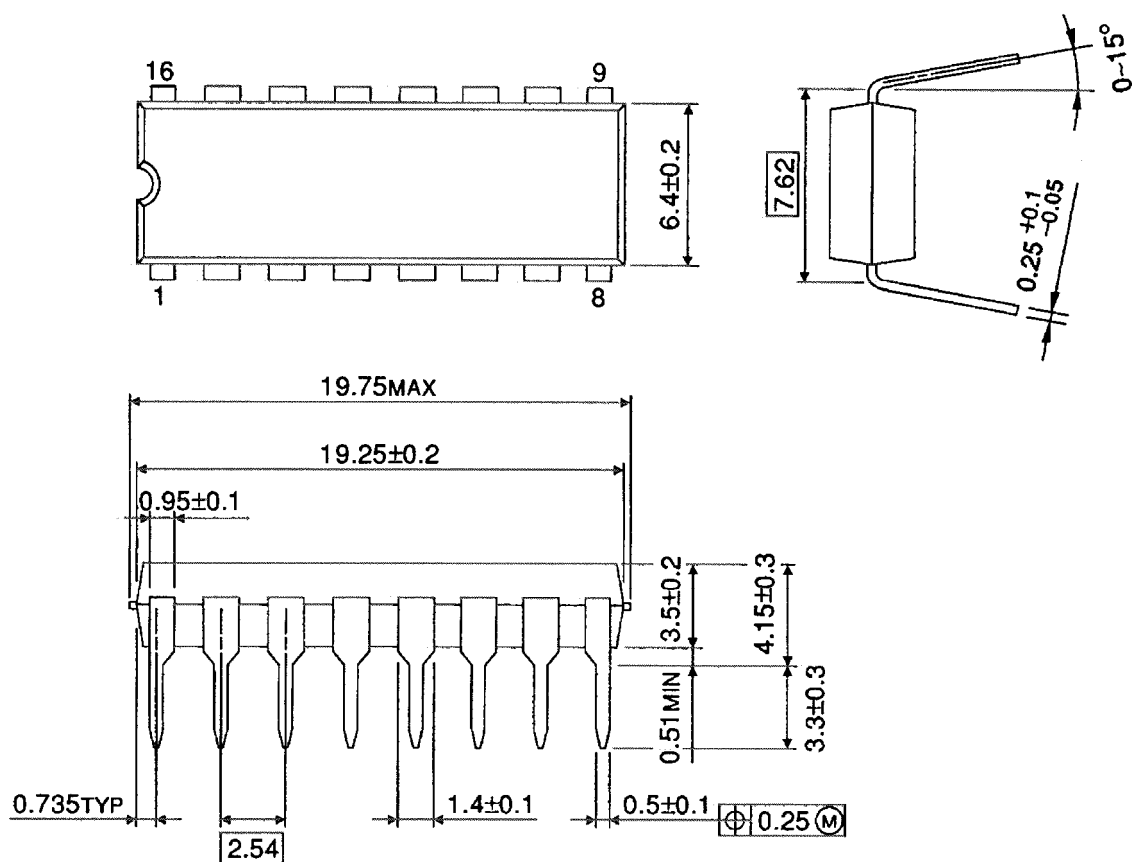
Waveform 5



Package Dimensions

DIP16-P-300-2.54A

Unit : mm

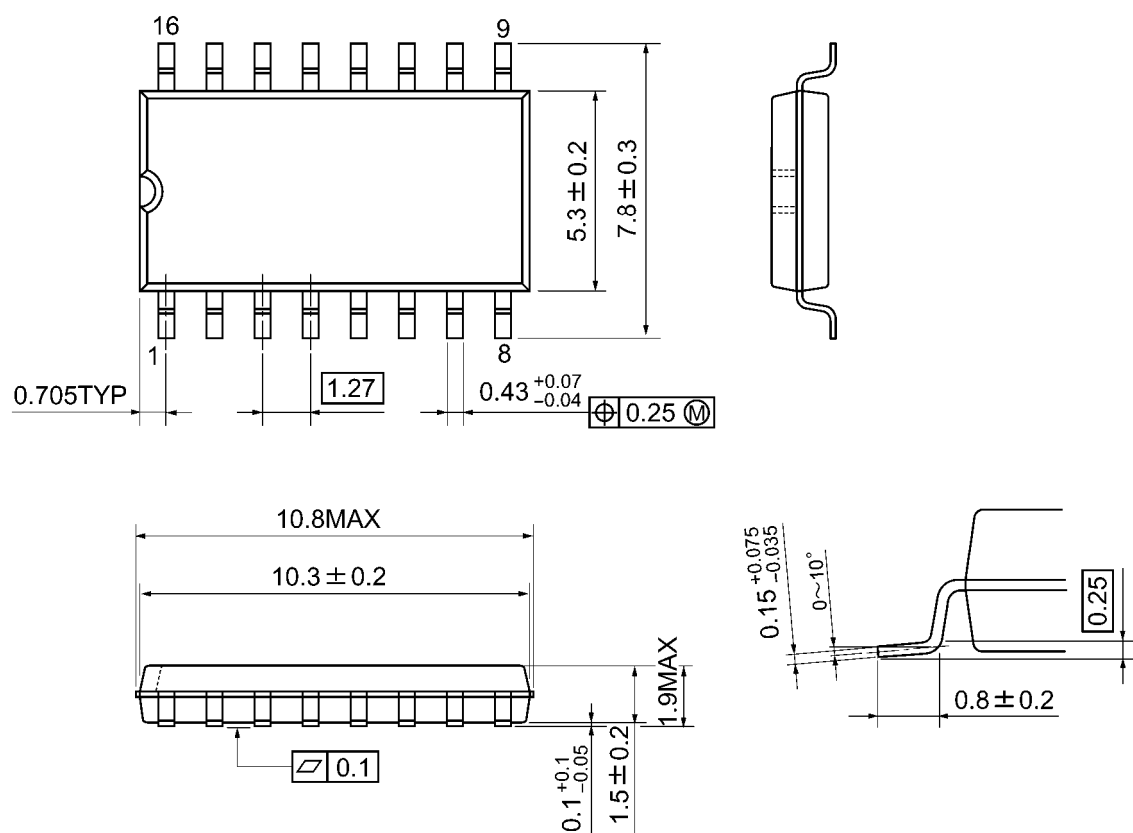


Weight: 1.00 g (typ.)

Package Dimensions

SOP16-P-300-1.27A

Unit: mm



Weight: 0.18 g (typ.)

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